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## APPLICANTS

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 \*\* CONTINUING DATA *none ACW* \*\*\*\*\*

 \*\* FOREIGN APPLICATIONS *ACW* \*\*\*\*\*  
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IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged Examiner's Signature <i>[Signature]</i> Initials	STATE OR  COUNTRY KOREA, REPUBLIC OF	SHEETS  DRAWING 3	TOTAL  CLAIMS 33	INDEPENDENT  CLAIMS 4
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## TITLE

Method of forming an underlayer of a bi-layer resist film and method of fabricating a semiconductor device using the same

FILING FEE

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 1090

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 No. \_\_\_\_\_ to charge/credit DEPOSIT ACCOUNT  
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- ☐ 1.17 Fees ( Processing Ext. of time )
- ☐ 1.18 Fees ( Issue )
- ☐ Other